

AMKOR TECHNOLOGY INC

Form 8-K

August 10, 2005

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**UNITED STATES SECURITIES AND EXCHANGE COMMISSION  
Washington, DC 20549**

**FORM 8-K  
CURRENT REPORT  
Pursuant to Section 13 or 15(d) of the  
Securities Exchange Act of 1934  
Date of Report (Date of earliest event reported)  
August 5, 2005**

**AMKOR TECHNOLOGY, INC.**  
(Exact name of registrant as specified in its charter)

**DELAWARE**

**000-29472**

**23-1722724**

(State or Other Jurisdiction of  
Incorporation)

(Commission File Number)

(IRS Employer  
Identification No.)

**1900 South Price Road  
Chandler, AZ 85248**

(Address of Principal Executive Offices, including Zip Code)  
**(480) 821-5000**

(Registrant's telephone number, including area code)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

- Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
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Pre-commencement  
communications  
pursuant to  
Rule 13e-4(c)  
under the Exchange  
Act (17 CFR  
240.13e-4(c))

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**Item 1.01. Entry Into a Material Definitive Agreement.**

On August 5, 2005 Amkor Technology, Inc. ( Amkor ) reached resolution with Fairchild Semiconductor Corporation ( Fairchild ) and Sumitomo Bakelite Co., Ltd., Sumitomo Plastics America, Inc. and Sumitomo Bakelite Singapore Pte. Ltd. (collectively Sumitomo ) with respect to pending litigation involving allegedly defective epoxy mold compound. Amkor has agreed to pay Fairchild \$3.0 million and release its claims against Sumitomo in consideration of a release from all claims against Amkor related to this litigation. This settlement was previously accrued for in our Consolidated Statement of Operations for the three months ended March 31, 2005.

Amkor will continue to incur legal expenses in defense of its other pending case related to the mold compound litigation matter. This pending case is discussed in Amkor s June 30, 2005 Form 10-Q.

**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

**AMKOR TECHNOLOGY, INC.**

By: /s/ Kenneth T. Joyce

Kenneth T. Joyce  
Chief Financial Officer

Date: August 10, 2005